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Switching Diode

DA5S101K0R

DA5S101K0R

Panasonic

Silicon epitaxial planar type

For high speed switching circuits DA4J101K in SSMini5 type package

■ Features

- · Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 21
- Basic Part Number : Dual DA2J101 (Parallel)
- Packaging

Embossed type (Thermo-compression sealing): 8 000 pcs / reel (standard)

	Unit: mm				
1.6					
5	0. 2 0. 13				
(0.5) (0.	5)				
1. Anode	1 4. Cathode 2				
2. N.C.	5. Cathode 1				
3. Anode	2				
Panasonic	SSMini5-F4-B				
JEITA	SC-107BB				
Code	SOT-665				

■ Absolute Maximum Ratings Ta = 25 °C

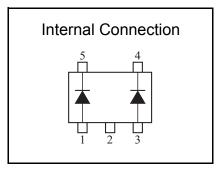
Parameter		Symbol	Rating	Unit	
Reverse voltage		VR	80	V	
Maximum peak reverse voltage	VRM	80	V		
Forward current	Single	IF	100	mA	
	Double		75		
Repetitive peak	Single	IFM	225	mA	
forward current *1	Double	II-IVI	170		
Junction temperature		Tj	150	°C	
Operating ambient temperature		Topr	-40 to +85	°C	
Storage temperature		Tstg	-55 to +150	°C	

Note) *1: t = 1 s

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Revised

: 2013-06-19



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Revision . 3

Switching Diode

DA5S101K0R

Panasonic

■ Electrical Characteristics Ta = 25 °C ± 3 °C

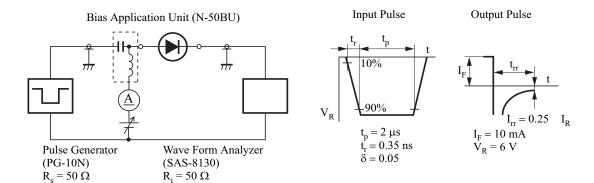
Symbol	Conditions	Min	Тур	Max	Unit
VF	IF = 100 mA		0.92	1.20	V
VR	IR = 100 μA	80			V
IR	VR = 80 V			100	nA
Ct	VR = 0 V , f = 1 MHz			1.2	pF
trr	IF = 10 mA , VR = 6 V Irr = 0.25 x IR			3	ns
	VF VR IR Ct	VF	VF	VF	VF IF = 100 mA 0.92 1.20 VR IR = 100 μA 80 100 IR VR = 80 V 100 Ct VR = 0 V , f = 1 MHz 1.2 trr IF = 10 mA , VR = 6 V 3

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. Absolute frequency of input and output is 100 MHz.
 - 3. *1: trr test circuit

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: 2013-06-19



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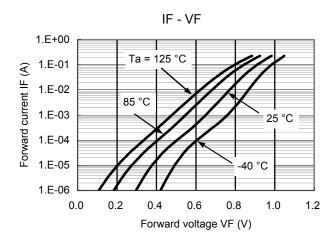
Revision . 3

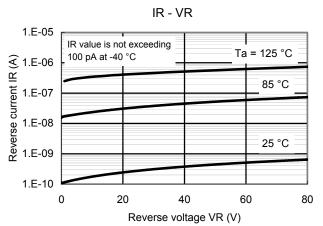
Panasonic

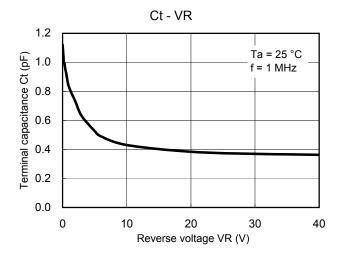
Switching Diode

DA5S101K0R

Technical Data (reference)







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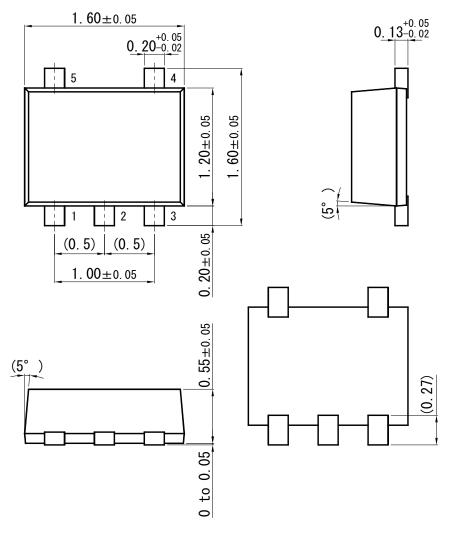
Switching Diode

DA5S101K0R

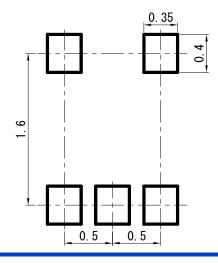
SSMini5-F4-B

Panasonic

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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